

# ANTREX Electronics

Electronic Components Sourcing Information

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## Product Reference Information

**Part Number:** IKW50N120CS7XKSA1  
**Manufacturer:** Infineon Technologies  
**Package:** TO-247-3  
**Availability:** Please confirm with sales

**Product Page:**

<https://antrexco.com/product/details/infineon-technologies/ikw50n120cs7xksa1.html>

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## Quality & Trust

New & Original Components

Supplier verification and packaging condition review

CoC / RoHS / REACH documents available on request

Secure sourcing support for OEM / EMS projects

**Note:**

This PDF includes an ANTREX product reference cover page.

The original manufacturer datasheet follows from the next page.

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## Short circuit rugged 1200 V TRENCHSTOP™ IGBT 7 technology copacked with soft and fast recovery Emitter Controlled 7 diode

### Features

- $V_{CE}=1200\text{ V}$
- $I_C=50\text{ A}$
- IGBT co-packed with full current, soft and low  $Q_{rr}$  diode
- Low saturation voltage  $V_{CE(sat)} = 2.0\text{ V}$  at  $T_{vj}=175\text{ °C}$
- Optimized for hard switching topologies (2-L inverter, 3-L NPC T-type, ...)
- Short circuit ruggedness 8  $\mu\text{sec}$
- Wide range of  $dv/dt$  controllability
- Complete product spectrum and PSpice Models: <http://www.infineon.com/igbt/>

### Potential applications

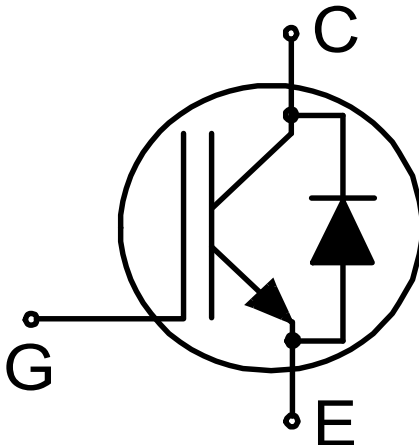
- Industrial Drives
- Industrial Power Supplies
- Solar Inverters

### Product validation

- Product Validation: Qualified for industrial applications according to the relevant tests of JEDEC47/20/22



### Description



| Type         | Package    | Marking |
|--------------|------------|---------|
| IKW50N120CS7 | PG-TO247-3 | K50MCS7 |



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**1 Package**

## 1 Package

**Table 1** Characteristic values

| Parameter                                                     | Symbol        | Note or test condition                            | Values |      |      | Unit |
|---------------------------------------------------------------|---------------|---------------------------------------------------|--------|------|------|------|
|                                                               |               |                                                   | Min.   | Typ. | Max. |      |
| Internal emitter inductance measured 5mm. (0.197in) from case | $L_E$         |                                                   |        | 13.0 |      | nH   |
| Storage temperature                                           | $T_{stg}$     |                                                   | -55    |      | 150  | °C   |
| Soldering temperature                                         |               | wave soldering 1.6mm (0.063in.) from case for 10s |        |      | 260  | °C   |
| Mounting torque , M3 screw<br>Maximum of mounting process: 3  | $M$           |                                                   |        |      | 0.6  | Nm   |
| Thermal resistance, junction-ambient                          | $R_{th(j-a)}$ |                                                   |        |      | 40   | K/W  |

## 2 IGBT

**Table 2** Maximum rated values

| Parameter                                              | Symbol      | Note or test condition                                                                                                                                                 |                       | Values   | Unit          |
|--------------------------------------------------------|-------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------|----------|---------------|
| Collector-emitter voltage                              | $V_{CE}$    | $T_{vj} \geq 25\text{ °C}$                                                                                                                                             |                       | 1200     | V             |
| DC collector current, limited by $T_{vjmax}$           | $I_C$       | limited by bondwire                                                                                                                                                    | $T_C = 25\text{ °C}$  | 82       | A             |
|                                                        |             |                                                                                                                                                                        | $T_C = 100\text{ °C}$ | 68       |               |
| Pulsed collector current, $t_p$ limited by $T_{vjmax}$ | $I_{Cpuls}$ |                                                                                                                                                                        |                       | 150      | A             |
| Turn-off safe operating area                           |             | $V_{CE} \leq 1200\text{ V}, T_{vj} \leq 175\text{ °C}$                                                                                                                 |                       | 150      | A             |
| Gate-emitter voltage                                   | $V_{GE}$    |                                                                                                                                                                        |                       | $\pm 20$ | V             |
| Transient gate-emitter voltage                         | $V_{GE}$    | $t_p \leq 0.5\text{ }\mu\text{s}, D < 0.001$                                                                                                                           |                       | $\pm 25$ | V             |
| Short circuit withstand time                           | $t_{SC}$    | $V_{CC} \leq 600\text{ V}, V_{GE} = 15\text{ V}$ , Allowed number of short circuits < 1000, Time between short circuits $\geq 1.0\text{ s}$ , $T_{vj} = 150\text{ °C}$ |                       | 8        | $\mu\text{s}$ |
| Power dissipation                                      | $P_{tot}$   |                                                                                                                                                                        | $T_C = 25\text{ °C}$  | 428      | W             |
|                                                        |             |                                                                                                                                                                        | $T_C = 100\text{ °C}$ | 215      |               |

**Table 3** Characteristic values

| Parameter                            | Symbol              | Note or test condition                      |                          | Values |      |      | Unit |
|--------------------------------------|---------------------|---------------------------------------------|--------------------------|--------|------|------|------|
|                                      |                     |                                             |                          | Min.   | Typ. | Max. |      |
| Collector-emitter saturation voltage | $V_{CE\text{ sat}}$ | $I_C = 50.0\text{ A}, V_{GE} = 15\text{ V}$ | $T_{vj} = 25\text{ °C}$  |        | 1.65 | 2.00 | V    |
|                                      |                     |                                             | $T_{vj} = 175\text{ °C}$ |        | 2.00 |      |      |

**Table 3**                      **Characteristic values (continued)**

| Parameter                           | Symbol     | Note or test condition                                                                                                                                                                                        | Values |      |      | Unit          |
|-------------------------------------|------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|------|------|---------------|
|                                     |            |                                                                                                                                                                                                               | Min.   | Typ. | Max. |               |
| Gate-emitter threshold voltage      | $V_{GEth}$ | $I_C = 0.98 \text{ mA}$ , $V_{CE} = V_{GE}$ , $T_{vj} = 25^\circ\text{C}$                                                                                                                                     | 5.15   | 5.70 | 6.45 | V             |
| Zero gate voltage collector current | $I_{CES}$  | $V_{CE} = 1200 \text{ V}$ , $V_{GE} = 0 \text{ V}$ , $T_{vj} = 25^\circ\text{C}$                                                                                                                              |        |      | 40   | $\mu\text{A}$ |
|                                     |            | $T_{vj} = 175^\circ\text{C}$                                                                                                                                                                                  |        | 4000 |      |               |
| Gate-emitter leakage current        | $I_{GES}$  | $V_{CE} = 0 \text{ V}$ , $V_{GE} = 20 \text{ V}$                                                                                                                                                              |        |      | 100  | nA            |
| Transconductance                    | $g_{fs}$   | $I_C = 50.0 \text{ A}$ , $V_{CE} = 20 \text{ V}$ , $T_{vj} = 175^\circ\text{C}$                                                                                                                               |        | 21.0 |      | S             |
| Short circuit collector current     | $I_{SC}$   | $V_{CC} \leq 600 \text{ V}$ , $V_{GE} = 15 \text{ V}$ , $t_{SC} \leq 8 \mu\text{s}$ , Allowed number of short circuits < 1000, Time between short circuits $\geq 1.0 \text{ s}$ , $T_{vj} = 25^\circ\text{C}$ |        | 300  |      | A             |
| Input capacitance                   | $C_{ies}$  | $V_{CE} = 25 \text{ V}$ , $V_{GE} = 0 \text{ V}$ , $f = 100 \text{ kHz}$                                                                                                                                      |        | 7.2  |      | nF            |
| Output capacitance                  | $C_{oes}$  | $V_{CE} = 25 \text{ V}$ , $V_{GE} = 0 \text{ V}$ , $f = 100 \text{ kHz}$                                                                                                                                      |        | 140  |      | pF            |
| Reverse transfer capacitance        | $C_{res}$  | $V_{CE} = 25 \text{ V}$ , $V_{GE} = 0 \text{ V}$ , $f = 100 \text{ kHz}$                                                                                                                                      |        | 32   |      | pF            |
| Gate charge                         | $Q_G$      | $I_C = 50.0 \text{ A}$ , $V_{GE} = 15 \text{ V}$ , $V_{CE} = 960 \text{ V}$                                                                                                                                   |        | 290  |      | nC            |
| Turn-on delay time                  | $t_{don}$  | $V_{CE} = 600 \text{ V}$ , $V_{GE} = 15 \text{ V}$ , $R_{Gon} = 2.3 \Omega$ , $R_{Goff} = 2.3 \Omega$ , $T_{vj} = 25^\circ\text{C}$ , $I_C = 50.0 \text{ A}$                                                  |        | 29   |      | ns            |
|                                     |            | $T_{vj} = 175^\circ\text{C}$ , $I_C = 50.0 \text{ A}$                                                                                                                                                         |        | 26   |      |               |
| Rise time (inductive load)          | $t_r$      | $V_{CE} = 600 \text{ V}$ , $V_{GE} = 15 \text{ V}$ , $R_{Gon} = 2.3 \Omega$ , $R_{Goff} = 2.3 \Omega$ , $T_{vj} = 25^\circ\text{C}$ , $I_C = 50.0 \text{ A}$                                                  |        | 19   |      | ns            |
|                                     |            | $T_{vj} = 175^\circ\text{C}$ , $I_C = 50.0 \text{ A}$                                                                                                                                                         |        | 19   |      |               |
| Turn-off delay time                 | $t_{doff}$ | $V_{CE} = 600 \text{ V}$ , $V_{GE} = 15 \text{ V}$ , $R_{Gon} = 2.3 \Omega$ , $R_{Goff} = 2.3 \Omega$ , $T_{vj} = 25^\circ\text{C}$ , $I_C = 50.0 \text{ A}$                                                  |        | 170  |      | ns            |
|                                     |            | $T_{vj} = 175^\circ\text{C}$ , $I_C = 50.0 \text{ A}$                                                                                                                                                         |        | 225  |      |               |
| Fall time (inductive load)          | $t_f$      | $V_{CE} = 600 \text{ V}$ , $V_{GE} = 15 \text{ V}$ , $R_{Gon} = 2.3 \Omega$ , $R_{Goff} = 2.3 \Omega$ , $T_{vj} = 25^\circ\text{C}$ , $I_C = 50.0 \text{ A}$                                                  |        | 100  |      | ns            |
|                                     |            | $T_{vj} = 175^\circ\text{C}$ , $I_C = 50.0 \text{ A}$                                                                                                                                                         |        | 245  |      |               |
| Turn-on energy                      | $E_{on}$   | $V_{CE} = 600 \text{ V}$ , $V_{GE} = 15 \text{ V}$ , $R_{Gon} = 2.3 \Omega$ , $R_{Goff} = 2.3 \Omega$ , $T_{vj} = 25^\circ\text{C}$ , $I_C = 50.0 \text{ A}$                                                  |        | 2.80 |      | mJ            |
|                                     |            | $T_{vj} = 175^\circ\text{C}$ , $I_C = 50.0 \text{ A}$                                                                                                                                                         |        | 4.30 |      |               |
| Turn-off energy                     | $E_{off}$  | $V_{CE} = 600 \text{ V}$ , $V_{GE} = 15 \text{ V}$ , $R_{Gon} = 2.3 \Omega$ , $R_{Goff} = 2.3 \Omega$ , $T_{vj} = 25^\circ\text{C}$ , $I_C = 50.0 \text{ A}$                                                  |        | 2.20 |      | mJ            |
|                                     |            | $T_{vj} = 175^\circ\text{C}$ , $I_C = 50.0 \text{ A}$                                                                                                                                                         |        | 4.70 |      |               |

**Table 3** Characteristic values (continued)

| Parameter                              | Symbol     | Note or test condition                                                                            | Values |      |      | Unit |
|----------------------------------------|------------|---------------------------------------------------------------------------------------------------|--------|------|------|------|
|                                        |            |                                                                                                   | Min.   | Typ. | Max. |      |
| Total switching energy                 | $E_{ts}$   | $V_{CE} = 600 \text{ V}, V_{GE} = 15 \text{ V},$<br>$R_{Gon} = 2.3 \Omega, R_{Goff} = 2.3 \Omega$ |        | 5.00 |      | mJ   |
|                                        |            |                                                                                                   |        | 9.00 |      |      |
| IGBT thermal resistance, junction-case | $R_{thjc}$ |                                                                                                   |        | 0.25 | 0.35 | K/W  |
| Operating junction temperature         | $T_{vj}$   |                                                                                                   | -40    |      | 175  | °C   |

### 3 Diode

**Table 4** Maximum rated values

| Parameter                                     | Symbol      | Note or test condition      | Values                 | Unit |
|-----------------------------------------------|-------------|-----------------------------|------------------------|------|
| Repetitive peak reverse voltage               | $V_{RRM}$   | $T_{vj} \geq 25 \text{ °C}$ | 1200                   | V    |
| Diode forward current, limited by $T_{vjmax}$ | $I_F$       | limited by bondwire         | $T_C = 25 \text{ °C}$  | A    |
|                                               |             |                             | $T_C = 100 \text{ °C}$ |      |
| Diode pulsed current, limited by $T_{vjmax}$  | $I_{Fpuls}$ |                             | 150                    | A    |
| Power dissipation                             | $P_{tot}$   | $T_C = 25 \text{ °C}$       | 250                    | W    |
|                                               |             | $T_C = 100 \text{ °C}$      | 125                    |      |

**Table 5** Characteristic values

| Parameter                     | Symbol   | Note or test condition                      | Values                                               |      |      | Unit          |
|-------------------------------|----------|---------------------------------------------|------------------------------------------------------|------|------|---------------|
|                               |          |                                             | Min.                                                 | Typ. | Max. |               |
| Diode forward voltage         | $V_F$    | $I_F = 50.0 \text{ A}$                      |                                                      | 1.65 | 2.15 | V             |
|                               |          |                                             |                                                      | 1.60 |      |               |
| Reverse leakage current       | $I_R$    | $V_R = 1200 \text{ V}$                      | $T_{vj} = 25 \text{ °C}$                             |      | 40   | $\mu\text{A}$ |
|                               |          |                                             | $T_{vj} = 175 \text{ °C}$                            | 4000 |      |               |
| Diode reverse recovery time   | $t_{rr}$ | $V_R = 600 \text{ V}, R_{Gon} = 2.3 \Omega$ | $T_{vj} = 25 \text{ °C},$<br>$I_F = 50.0 \text{ A}$  | 165  |      | ns            |
|                               |          |                                             | $T_{vj} = 175 \text{ °C},$<br>$I_F = 50.0 \text{ A}$ | 305  |      |               |
| Diode reverse recovery charge | $Q_{rr}$ | $V_R = 600 \text{ V}, R_{Gon} = 2.3 \Omega$ | $T_{vj} = 25 \text{ °C},$<br>$I_F = 50.0 \text{ A}$  | 3.20 |      | $\mu\text{C}$ |
|                               |          |                                             | $T_{vj} = 175 \text{ °C},$<br>$I_F = 50.0 \text{ A}$ | 8.25 |      |               |

**Table 5** Characteristic values (continued)

| Parameter                                            | Symbol       | Note or test condition                      | Values |                                                 |      | Unit |
|------------------------------------------------------|--------------|---------------------------------------------|--------|-------------------------------------------------|------|------|
|                                                      |              |                                             | Min.   | Typ.                                            | Max. |      |
| Diode peak reverse recovery current                  | $I_{rrm}$    | $V_R = 600 \text{ V}, R_{Gon} = 2.3 \Omega$ |        | $T_{vj} = 25 \text{ °C}, I_F = 50.0 \text{ A}$  | 40.0 | A    |
|                                                      |              |                                             |        | $T_{vj} = 175 \text{ °C}, I_F = 50.0 \text{ A}$ | 54.0 |      |
| Diode peak rate off fall of reverse recovery current | $di_{rr}/dt$ | $V_R = 600 \text{ V}, R_{Gon} = 2.3 \Omega$ |        | $T_{vj} = 25 \text{ °C}, I_F = 50.0 \text{ A}$  | -290 | A/μs |
|                                                      |              |                                             |        | $T_{vj} = 175 \text{ °C}, I_F = 50.0 \text{ A}$ | -185 |      |
| Reverse recovery energy                              | $E_{rec}$    | $V_R = 600 \text{ V}, R_{Gon} = 2.3 \Omega$ |        | $T_{vj} = 25 \text{ °C}, I_F = 50.0 \text{ A}$  | 1.00 | mJ   |
|                                                      |              |                                             |        | $T_{vj} = 175 \text{ °C}, I_F = 50.0 \text{ A}$ | 3.10 |      |
| Diode thermal resistance, junction-case              | $R_{thjc}$   |                                             |        | 0.45                                            | 0.60 | K/W  |
| Operating junction temperature                       | $T_{vj}$     |                                             | -40    |                                                 | 175  | °C   |

**Note:** For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

Dynamic test circuit, parasitic inductance  $L_\sigma = 30 \text{ nH}$ ,  $C_\sigma = 28 \text{ pF}$

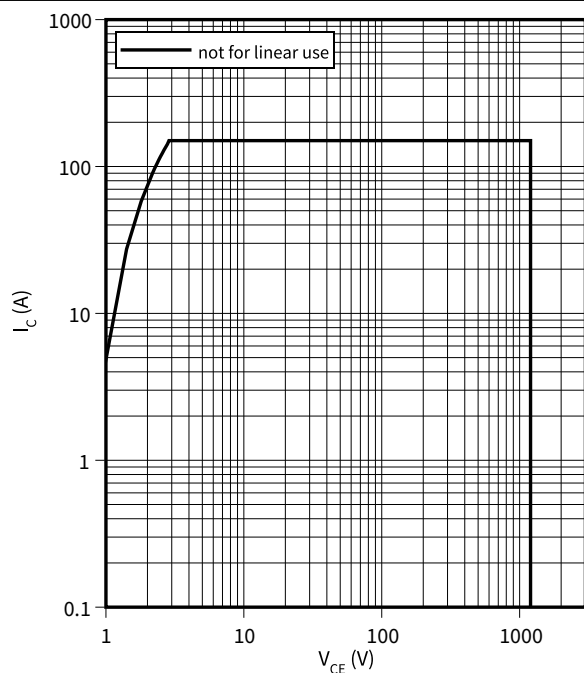
4 Characteristics diagrams

## 4 Characteristics diagrams

### Reverse bias safe operating area, IGBT

$$I_C = f(V_{CE})$$

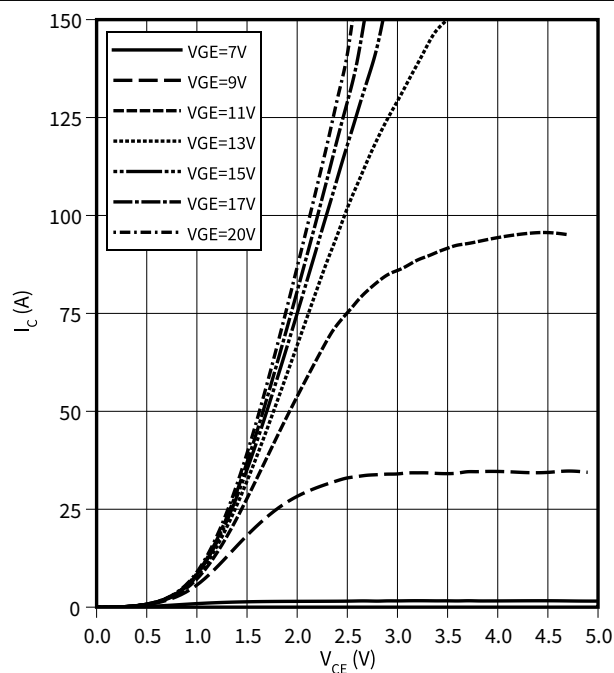
$T_{vj} \leq 175^\circ\text{C}$ ,  $V_{GE} = 15\text{ V}$



### Typical output characteristic, IGBT

$$I_C = f(V_{CE})$$

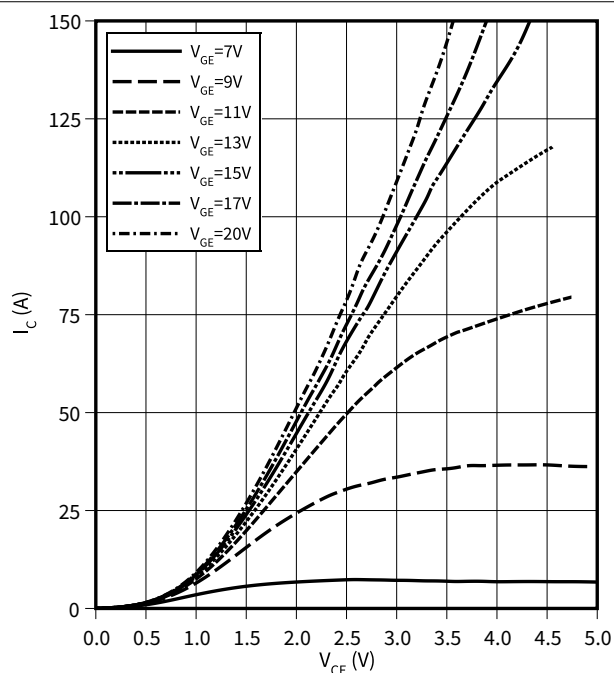
$T_{vj} = 25^\circ\text{C}$



### Typical output characteristic, IGBT

$$I_C = f(V_{CE})$$

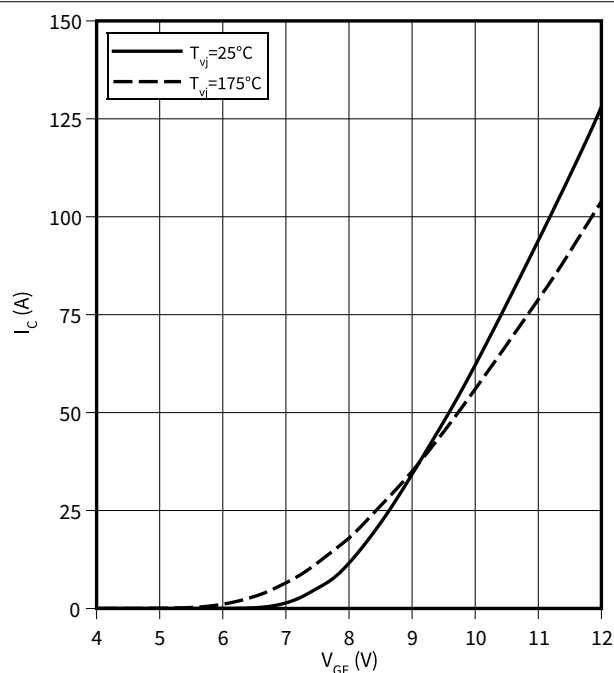
$T_{vj} = 175^\circ\text{C}$



### Typical transfer characteristic, IGBT

$$I_C = f(V_{GE})$$

$V_{CE} = 20\text{ V}$

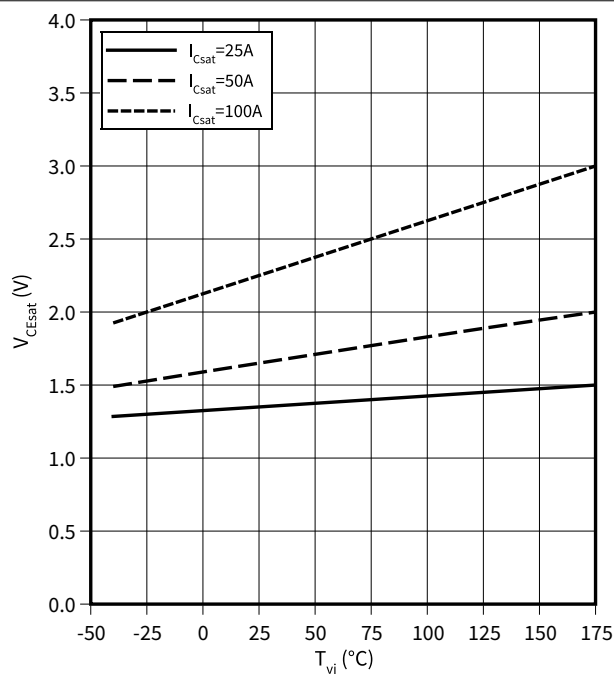


4 Characteristics diagrams

**Typical collector-emitter saturation voltage as a function of junction temperature, IGBT**

$$V_{CEsat} = f(T_{vj})$$

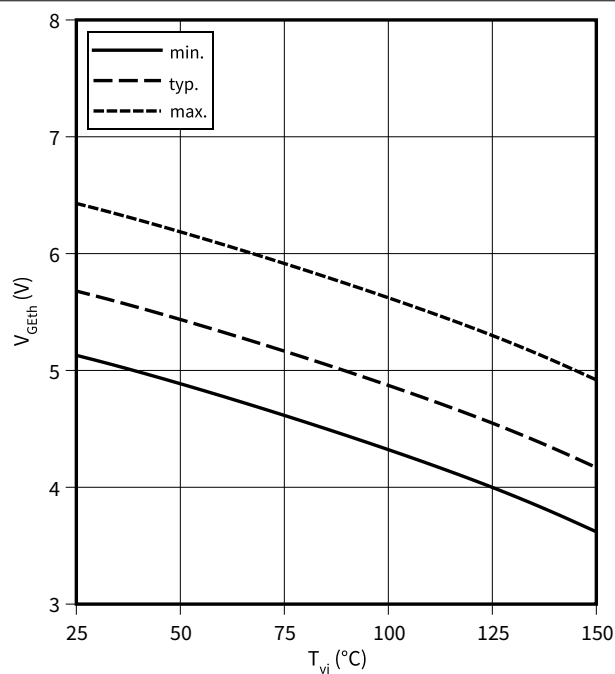
$$V_{GE} = 15 \text{ V}$$



**Gate-emitter threshold voltage as a function of junction temperature, IGBT**

$$V_{GEth} = f(T_{vj})$$

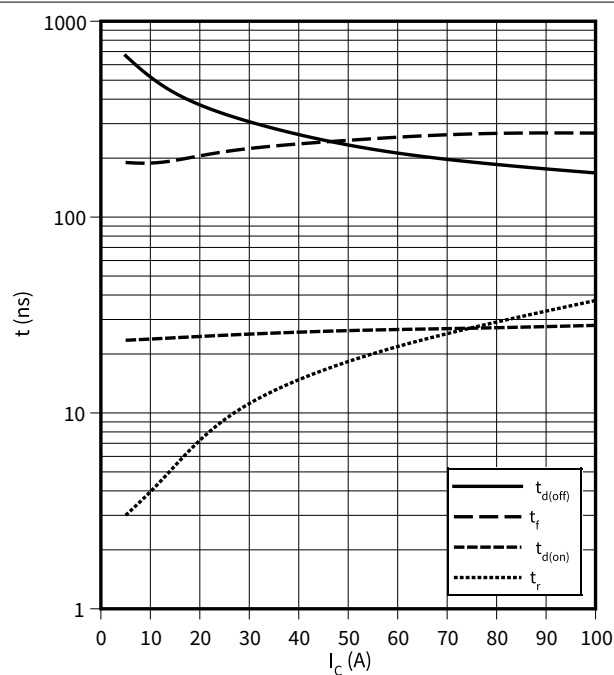
$$I_C = 0.98 \text{ mA}$$



**Typical switching times as a function of collector current, IGBT**

$$t = f(I_C)$$

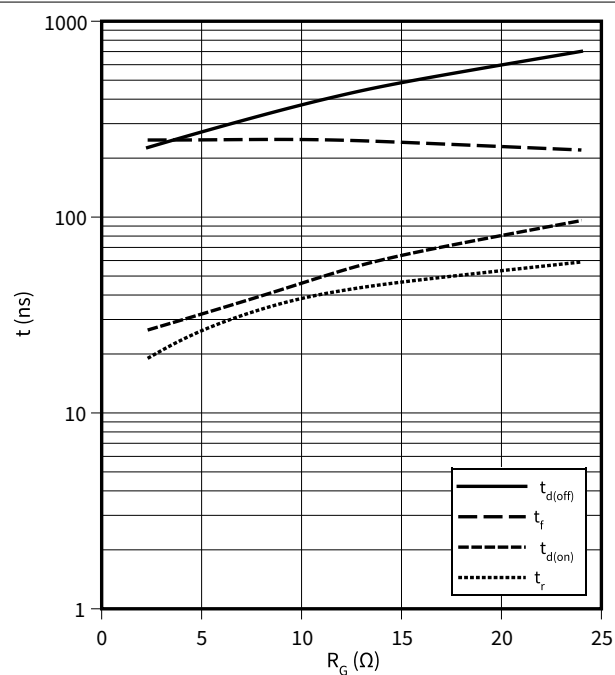
$$V_{CE} = 600 \text{ V}, T_{vj} = 175 \text{ °C}, V_{GE} = 0/15 \text{ V}, R_G = 2.3 \text{ } \Omega$$



**Typical switching times as a function of gate resistor, IGBT**

$$t = f(R_G)$$

$$I_C = 50.0 \text{ A}, V_{CE} = 600 \text{ V}, T_{vj} = 175 \text{ °C}, V_{GE} = 0/15 \text{ V}$$

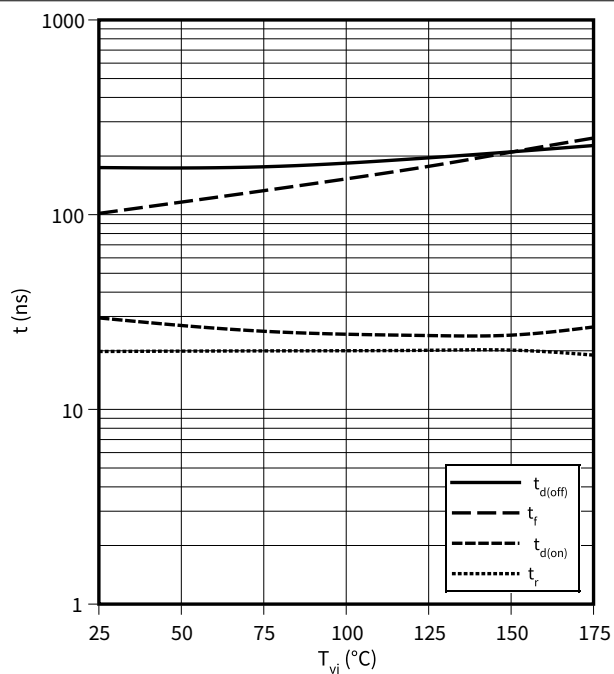


4 Characteristics diagrams

**Typical switching times as a function of junction temperature, IGBT**

$$t = f(T_{vj})$$

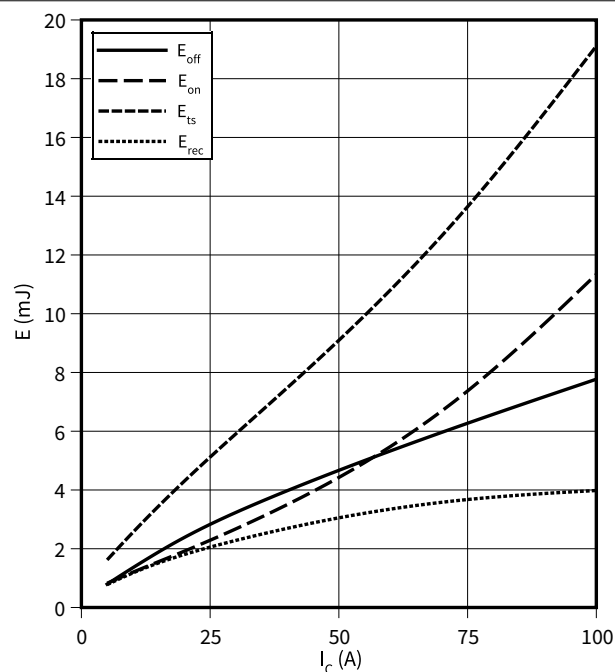
$I_C = 50.0 \text{ A}$ ,  $V_{CE} = 600 \text{ V}$ ,  $V_{GE} = 0/15 \text{ V}$ ,  $R_G = 2.3 \Omega$



**Typical switching energy losses as a function of collector current, IGBT**

$$E = f(I_C)$$

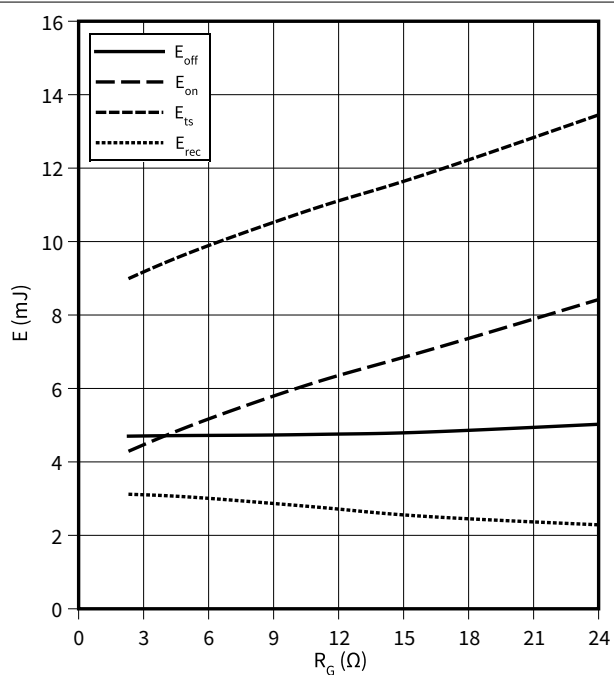
$V_{CE} = 600 \text{ V}$ ,  $T_{vj} = 175 \text{ }^{\circ}\text{C}$ ,  $V_{GE} = 0/15 \text{ V}$ ,  $R_G = 2.3 \Omega$



**Typical switching energy losses as a function of gate resistor, IGBT**

$$E = f(R_G)$$

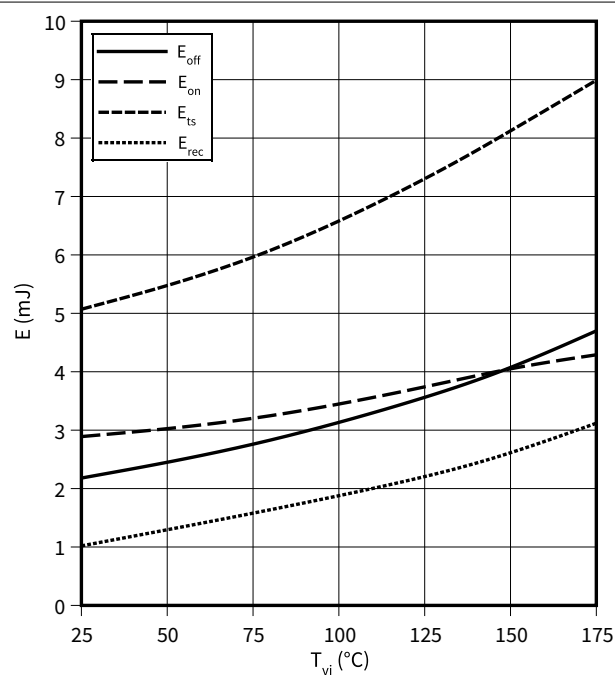
$I_C = 50.0 \text{ A}$ ,  $V_{CE} = 600 \text{ V}$ ,  $T_{vj} = 175 \text{ }^{\circ}\text{C}$ ,  $V_{GE} = 0/15 \text{ V}$



**Typical switching energy losses as a function of junction temperature, IGBT**

$$E = f(T_{vj})$$

$I_C = 50.0 \text{ A}$ ,  $V_{CE} = 600 \text{ V}$ ,  $V_{GE} = 0/15 \text{ V}$ ,  $R_G = 2.3 \Omega$

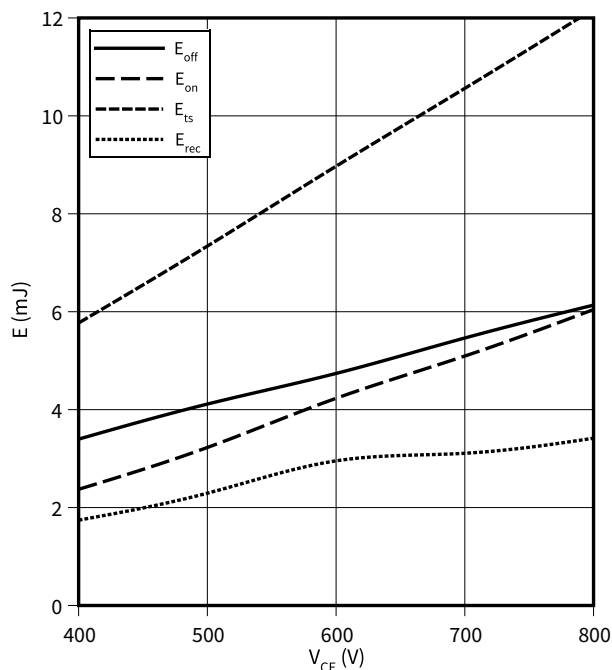


4 Characteristics diagrams

**Typical switching energy losses as a function of collector emitter voltage, IGBT**

$$E = f(V_{CE})$$

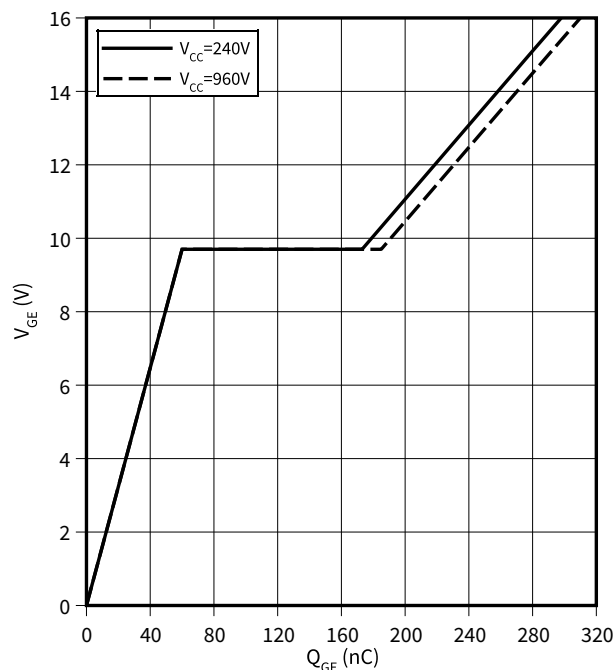
$I_C = 50.0 \text{ A}$ ,  $T_{vj} = 175 \text{ °C}$ ,  $V_{GE} = 0/15 \text{ V}$ ,  $R_G = 2.3 \text{ } \Omega$



**Typical gate charge, IGBT**

$$V_{GE} = f(Q_{GE})$$

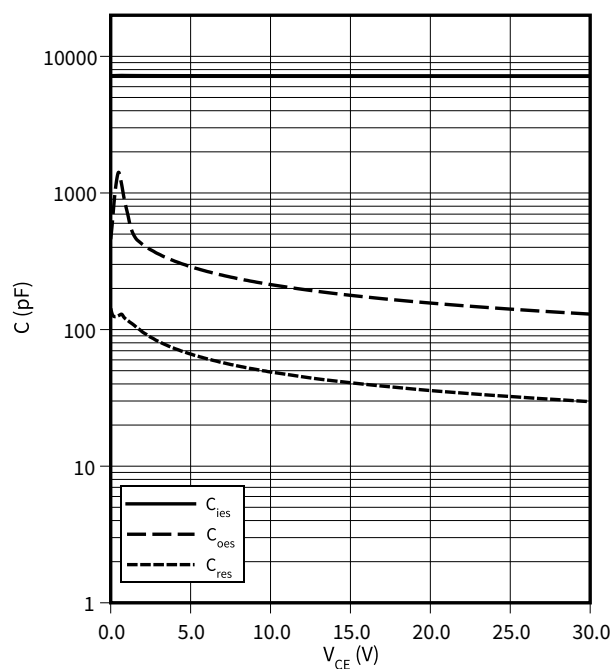
$I_C = 50.0 \text{ A}$



**Typical capacitance as a function of collector-emitter voltage, IGBT**

$$C = f(V_{CE})$$

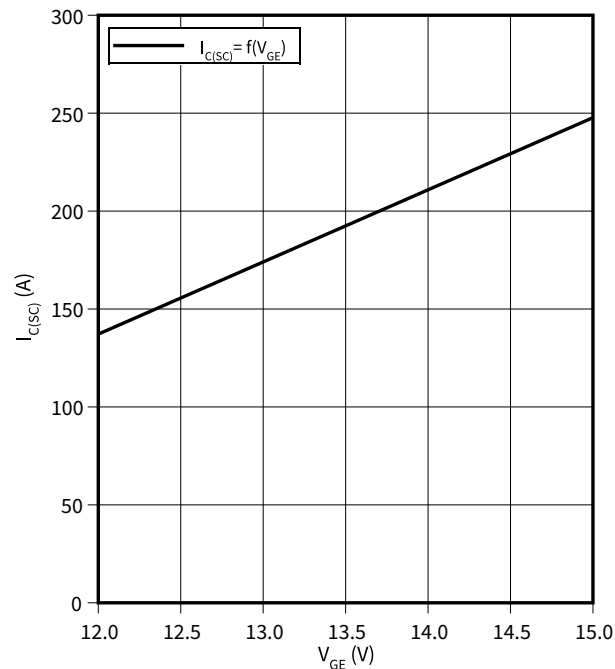
$f = 100 \text{ kHz}$ ,  $V_{GE} = 0 \text{ V}$



**Typical short circuit collector current as a function of gate-emitter voltage, IGBT**

$$I_{C(SC)} = f(V_{GE})$$

$T_{vj} = 150 \text{ °C}$ ,  $V_{CC} = 600 \text{ V}$

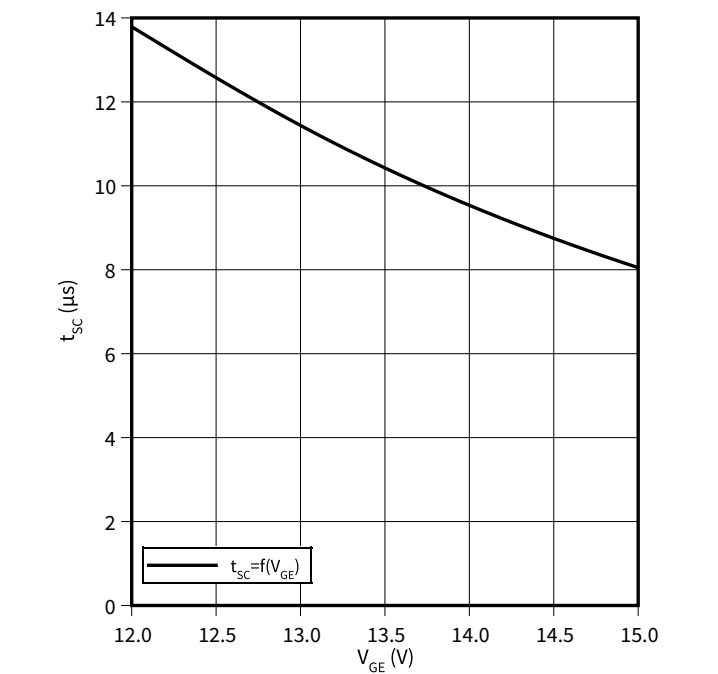


4 Characteristics diagrams

Short circuit withstand time as a function of gate-emitter voltage, IGBT

$$t_{SC} = f(V_{GE})$$

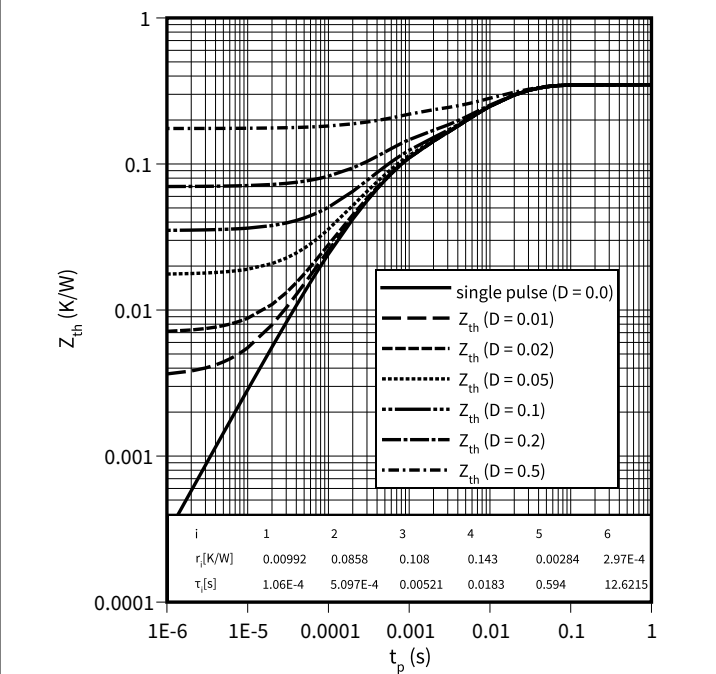
$$T_{vj} \leq 150\text{ }^{\circ}\text{C}, V_{CC} = 600\text{ V}$$



IGBT transient thermal impedance, IGBT

$$Z_{th} = f(t_p)$$

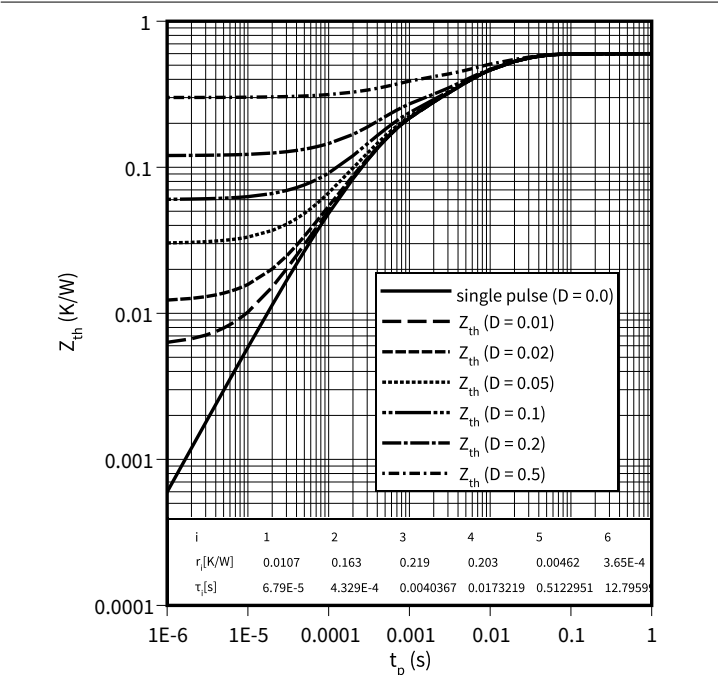
$$D = t_p/T$$



Diode transient thermal impedance as a function of pulse width, Diode

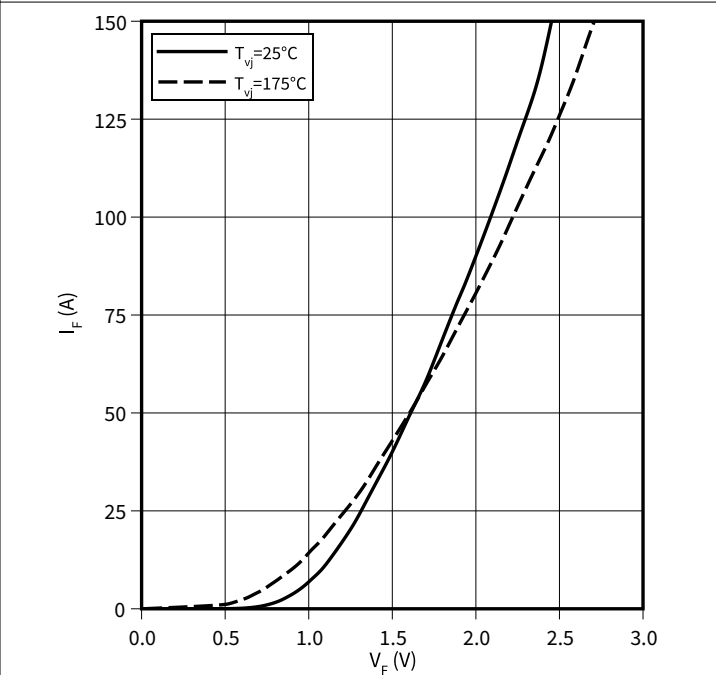
$$Z_{th} = f(t_p)$$

$$D = t_p/T$$



Typical diode forward current as a function of forward voltage, Diode

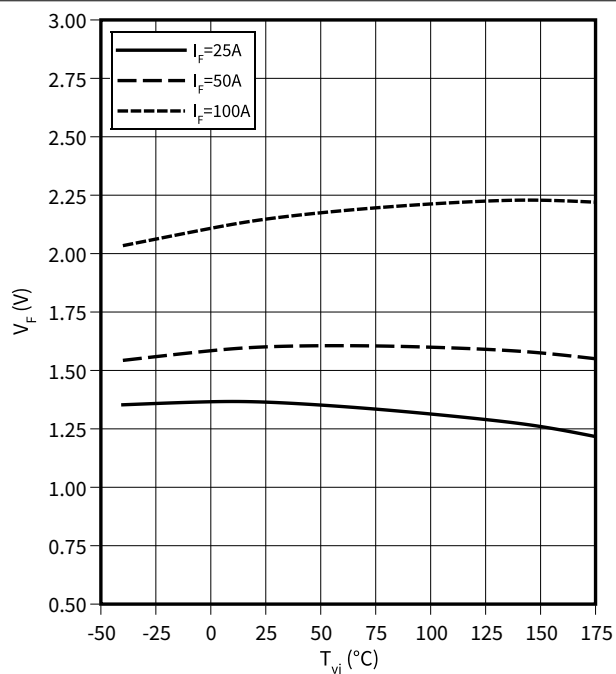
$$I_F = f(V_F)$$



4 Characteristics diagrams

**Typical diode forward voltage as a function of junction temperature, Diode**

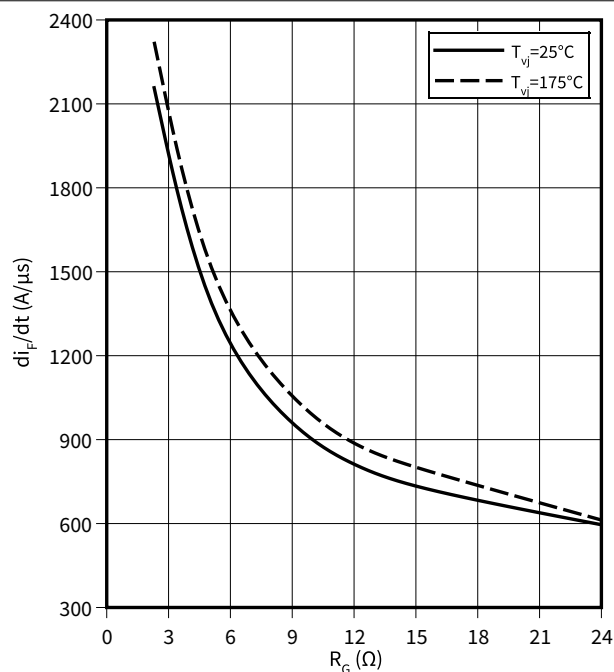
$$V_F = f(T_{vj})$$



**Typical diode current slope as a function of gate resistor, Diode**

$$di_F/dt = f(R_G)$$

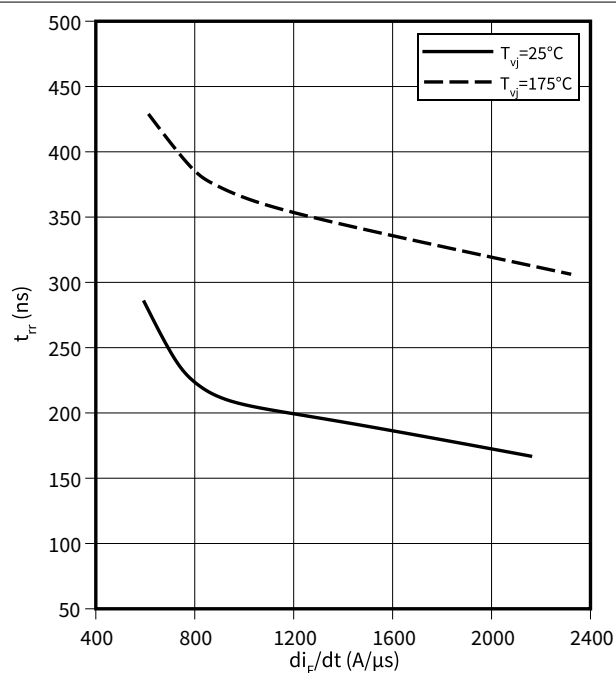
$$I_C = 50.0 A, V_{CE} = 600 V, V_{GE} = 0/15 V$$



**Typical reverse recovery time as a function of diode current slope, Diode**

$$t_{rr} = f(di_F/dt)$$

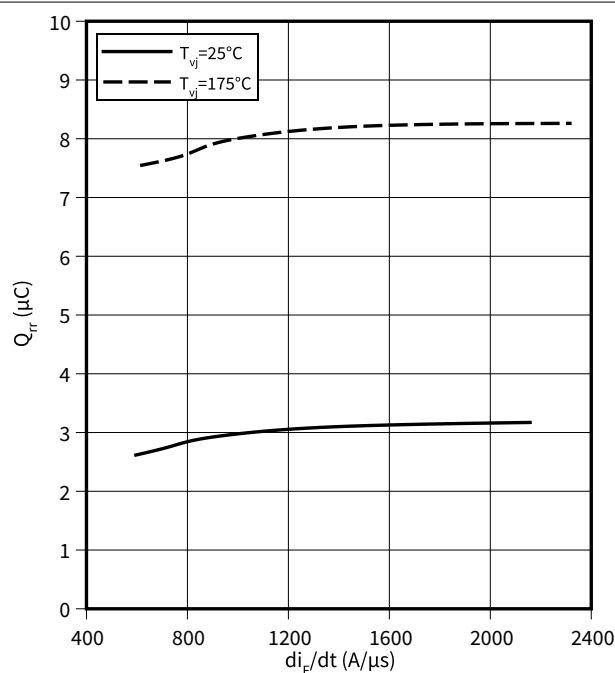
$$V_R = 600 V, I_F = 50.0 A$$



**Typical reverse recovery charge as a function of diode current slope, Diode**

$$Q_{rr} = f(di_F/dt)$$

$$V_R = 600 V, I_F = 50.0 A$$

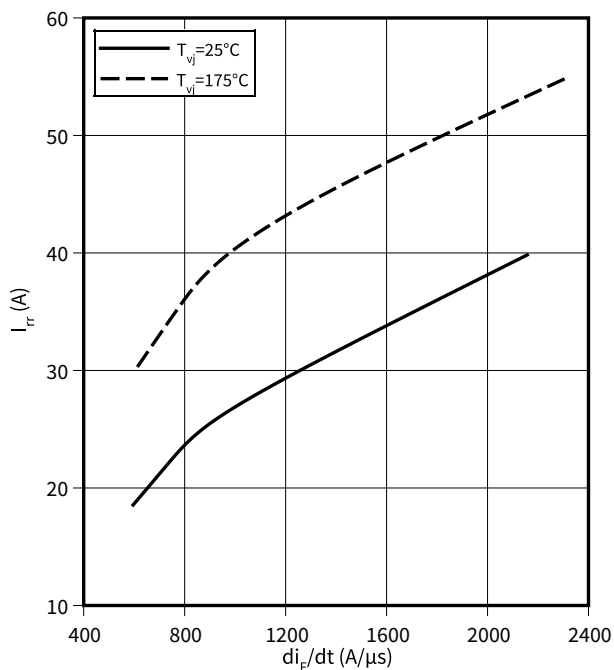


4 Characteristics diagrams

**Typical reverse recovery current as a function of diode current slope, Diode**

$$I_{rr} = f(di_F/dt)$$

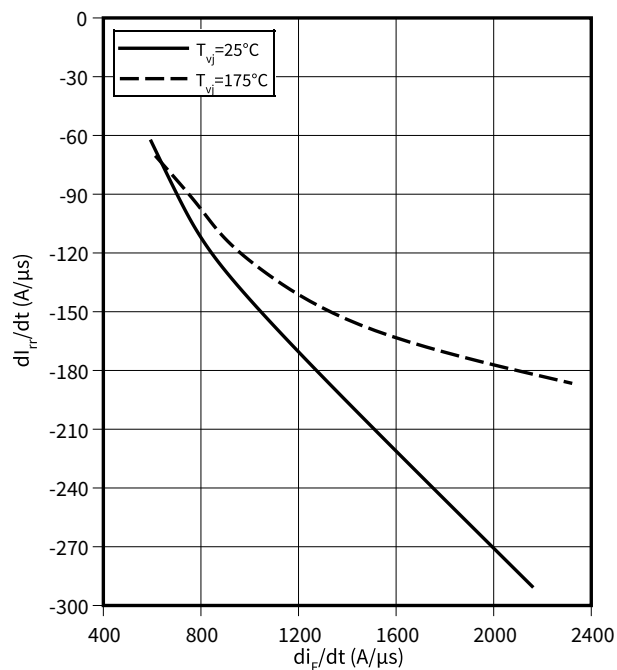
$V_R = 600 \text{ V}$ ,  $I_F = 50.0 \text{ A}$



**Typical diode peak rate of fall of reverse recovery current as a function of diode current slope, Diode**

$$dI_{rr}/dt = f(di_F/dt)$$

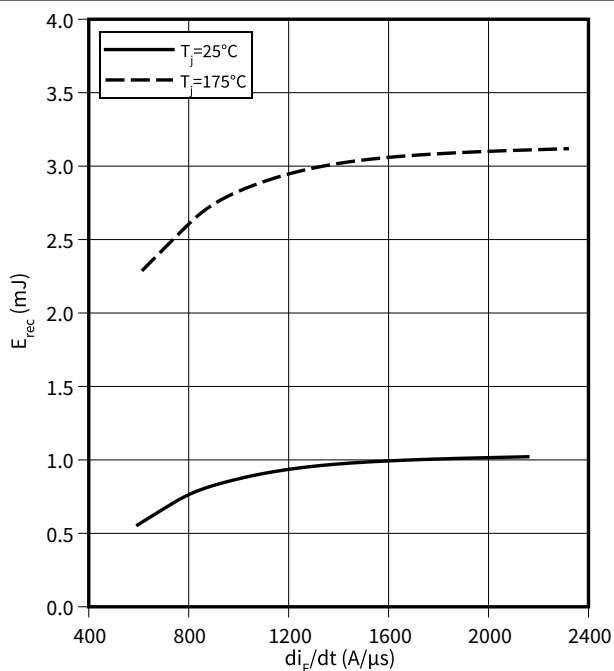
$V_R = 600 \text{ V}$ ,  $I_F = 50.0 \text{ A}$



**Typical reverse energy losses as a function of diode current slope, Diode**

$$E_{rec} = f(di_F/dt)$$

$V_R = 600 \text{ V}$ ,  $I_F = 50.0 \text{ A}$



5 Package outlines

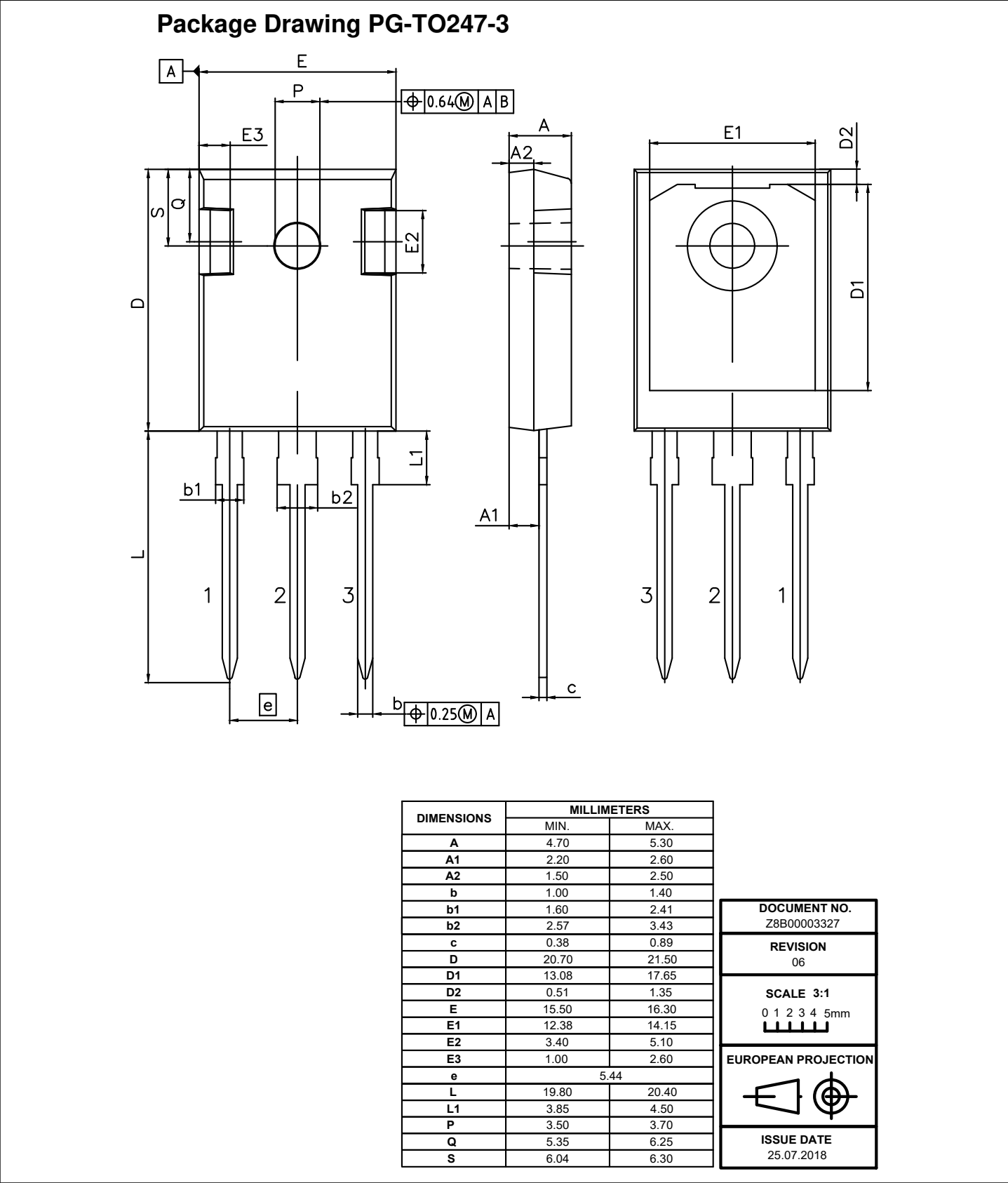


Figure 6

6 Testing conditions

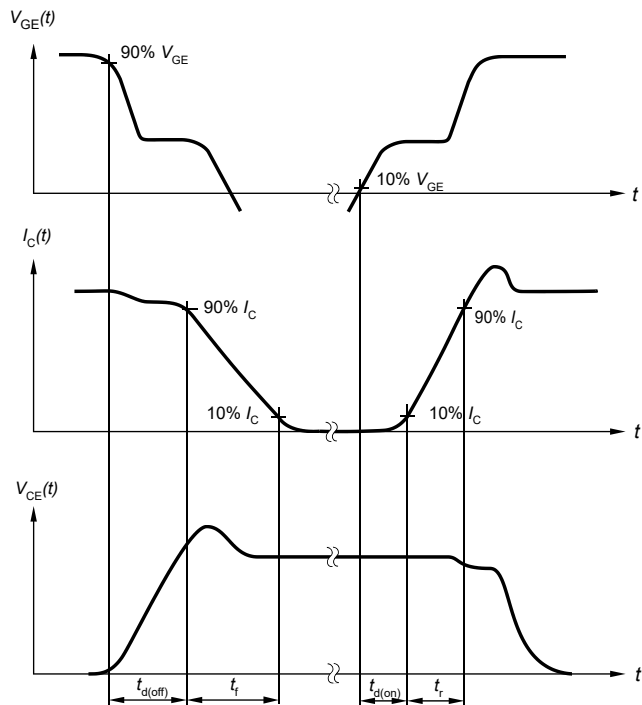


Figure A. Definition of switching times

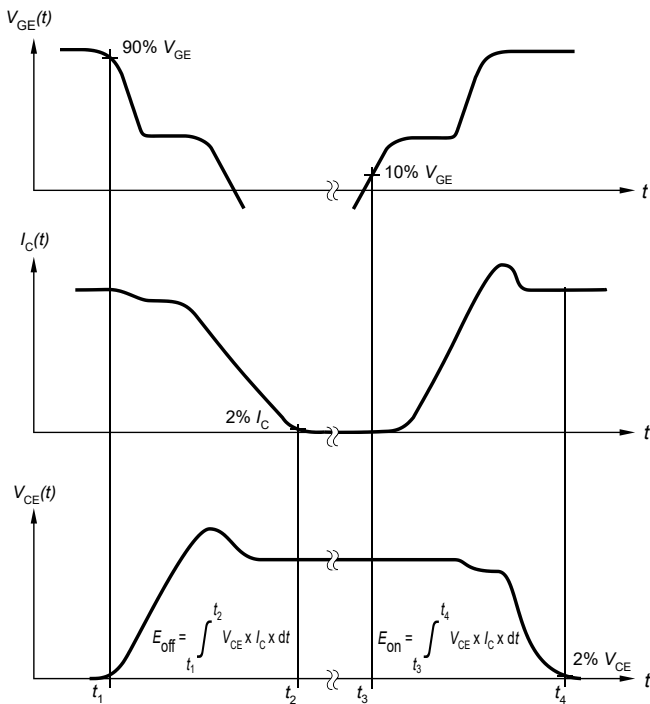


Figure B. Definition of switching losses

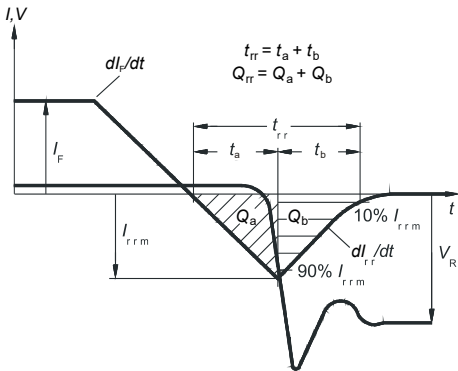


Figure C. Definition of diode switching characteristics

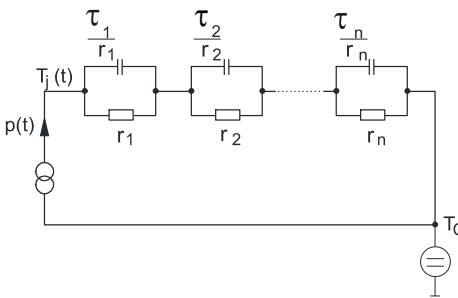


Figure D. Thermal equivalent circuit

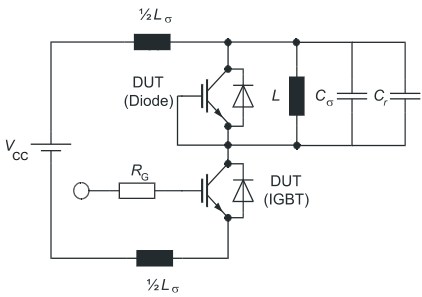


Figure E. Dynamic test circuit  
Parasitic inductance  $L_{\sigma}$ ,  
parasitic capacitor  $C_{\sigma}$ ,  
relief capacitor  $C_r$ ,  
(only for ZVT switching)

Figure 7

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